

L Number	Hits	Search Text	DB	Time stamp
-	5	6261919.pn. 6340604.pn. 4967146.pn. 6228684.pn. 5838361.pn.	USPAT	2003/02/24 14:12
-	3	6228676.pn. 4607219.pn. 6358776.pn.	USPAT	2002/09/25 12:13
-	11	"911924"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/02/24 14:19
-	7	(US-4607219-\$ or US-6358776-\$ or US-4967146-\$ or US-5838361-\$ or US-6261919-\$ or US-6228676-\$).did. or (US-20020016013-\$).did.	USPAT	2002/09/25 14:12
-	2	((US-4607219-\$ or US-6358776-\$ or US-4967146-\$ or US-5838361-\$ or US-6261919-\$ or US-6228676-\$).did. or (US-20020016013-\$).did.) and position	USPAT	2002/09/25 14:12
-	1	jpl1316209	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/24 14:40
-	7690	(TAKEHARA or NAKAGAWA) and (resin or mark)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/24 14:41
-	774	((TAKEHARA or NAKAGAWA) and (resin or mark) ) and (resin or mark).clm.	USPAT	2003/02/24 14:43
-	8	((TAKEHARA or NAKAGAWA) and (resin or mark) ) and (resin or mark).clm.) and test\$3.clm.	USPAT	2003/02/24 14:43
-	3	("5903044"   "6165815"   "6180435").PN.	USPAT	2003/02/24 14:52
-	31322	seal\$3 and mark\$3 and front and (back or opposite)	USPAT	2003/02/25 10:19
-	130	(seal\$3 and mark\$3 and front and (back or opposite)).clm.	USPAT	2003/02/25 10:20
-	15	((seal\$3 and mark\$3 and front and (back or opposite)).clm.) and (resin or encapsulant).clm.	USPAT	2003/02/25 10:20
-	304	(seal\$3 and mark\$3 and front and (back or opposite)) and (mark\$3 and front and (back or opposite)).clm.	USPAT	2003/02/25 10:21
-	5	((seal\$3 and mark\$3 and front and (back or opposite)) and (mark\$3 and front and (back or opposite)).clm.) and (semiconductor or chip)) and (resin or encapsulant).clm.	USPAT	2003/02/25 10:21
-	24	((seal\$3 and mark\$3 and front and (back or opposite)) and (mark\$3 and front and (back or opposite)).clm.) and (semiconductor or chip)	USPAT	2003/02/25 10:32
-	5	("4418467"   "5972234"   "6004405"   "6063695"   "6066513").PN.	USPAT	2003/02/25 10:28
-	1	6261919.URPN.	USPAT	2003/02/25 10:30
-	1101	(seal\$3 and mark\$3 and front and (back or opposite)) and backside	USPAT	2003/02/25 10:32
-	55	((seal\$3 and mark\$3 and front and (back or opposite)) and backside) and mark\$3.clm.	USPAT	2003/02/25 10:32
-	17	((seal\$3 and mark\$3 and front and (back or opposite)) and backside) and mark\$3.clm.) and (semiconductor or chip or wafer)	USPAT	2003/02/25 10:44
-	5	("4214249"   "4401992"   "5061341"   "6162651"   "6181017").PN.	USPAT	2003/02/25 10:42
-	1	"5688573".PN.	USPAT	2003/02/25 10:42
-	1	6162651.URPN.	USPAT	2003/02/25 10:43
-	0	6432796.URPN.	USPAT	2003/02/25 10:43
-	20	438/401 and resin	USPAT	2003/02/25 10:44

-	1447	(438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.	USPAT	2003/02/25 11:03
-	439	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.	USPAT	2003/02/25 11:04
-	90	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.) and (mark\$3 or scribing or enscribing)	USPAT	2003/02/25 11:04
-	35	"190" and (chip or wafer)	USPAT	2003/02/25 11:05
-	85	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.) and (mark\$3 or scribing or enscribing)) and (chip or wafer)	USPAT	2003/02/25 11:05
-	75	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.) and (mark\$3 or scribing or enscribing)) and (chip or wafer).clm.	USPAT	2003/02/25 11:05
-	52	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.) and (mark\$3 or scribing or enscribing)) and (chip or wafer).clm.) and seal\$3	USPAT	2003/02/25 11:05
-	35	((438/113 or 438/401 or 347/262 or 324/765 or 438/15 or 438/107 or 257/787 or 361/760 ).ccls. and (resin or encapsula\$4 or seal\$3).clm.) and (back or backside or opposite).clm.) and (mark\$3 or scribing or enscribing)) and (chip or wafer).clm.) and seal\$3.clm.	USPAT	2003/02/25 11:05